3.3V ECL 16:1 Multiplexer

The MC100LVE164 is a 16:1 multiplexer with a differential output. The select inputs (SEL0, 1, 2, 3) control which one of the sixteen data inputs (A0 - A15) is propragated to the output. The device is functionally equivalent to the MC100E164 except it operates from a 3.3 V supply. The device is packaged in the 32–lead LQFP. The LQFP has a 7x7 mm body with a 0.8 mm lead pitch.

Special attention to the design layout results in a typical skew between the 16 inputs of only 50 ps.

Features

- 850 ps Data Input to Output
- Differential Output
- ESD Protection: Human Body Model; >2 kV, Machine Model >200 V
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: $V_{CC} = 3.0 \text{ V}$ to 3.8 V with $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range: $V_{CC} = 0 V$ with $V_{EE} = -3.0 V$ to -3.8 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 2
 Www.DataSheet4U.c
 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 code V-0 @ 0.125 in, Oxygen Index: 28 to 34
- Transistor Count = 307 devices
- Pb-Free Packages are Available*

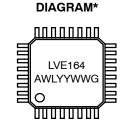


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32 LQFP FA SUFFIX CASE 873A



MARKING

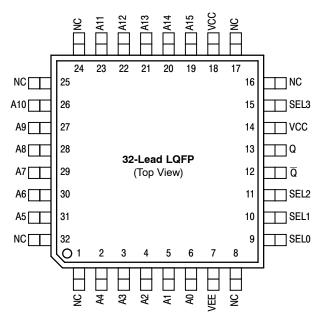
Α	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
G	= Pb-Free Package

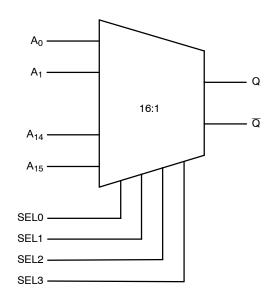
*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.





Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. Logic Diagram and Pinout Assignment

Table 1. PIN DESCRIPTION

PIN	FUNCTION				
A ₀ – A ₁₅	ECL Data Inputs				
SEL[0:3]	ECL Select Inputs				
Q, <u>Q</u>	ECL Differential Outputs				
V _{CC}	Positive Supply				
V_{EE}	Negative Supply				
NC	No Connect				

Table 2. FUNCTION TABLE

Figure 2. Logic Diagram

SEL3	SEL2	SEL1	SEL0	Data
L	L	L	L	A0
L	L	L	Н	A1
L	L	н	L	A2
L	L	н	н	A3
L	н	L	L	A4
L	н	L	н	A5
L	н	н	L	A6
L	н	н	н	A7
Н	L	L	L	A8
Н	L	L	н	A9
Н	L	н	L	A10
Н	L	н	н	A11
н	н	L	L	A12
н	н	L	н	A13
н	н	н	L	A14
н	н	н	н	A15

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V_{EE}	NECL Mode Power Supply	$V_{CC} = 0 V$		–8 to 0	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{array}{c} V_{I} \leq V_{CC} \\ V_{I} \geq V_{EE} \end{array}$	6 to 0 –6 to 0	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	32 LQFP 32 LQFP	80 55	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	32 LQFP	12 to 17	°C/W
T _{sol}	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

		-40°℃		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		34	45		34	45		37	45	mA
V _{OH}	Output HIGH Voltage (Note 2)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V _{OL}	Output LOW Voltage (Note 2)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	2135		2420	2135		2420	2135		2420	mV
V _{IL}	Input LOW Voltage (Single-Ended)	1490		1825	1490		1825	1490		1825	mV
I _{IH}	Input HIGH Current			150			150			150	μA
Ι _{ΙL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary \pm 0.3 V.

2. Outputs are terminated through a 50 Ω resistor to V_{CC} – 2.0 V.

		-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I_{EE}	Power Supply Current		34	45		34	45		37	45	mA
V _{OH}	Output HIGH Voltage (Note 4)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V _{OL}	Output LOW Voltage (Note 4)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single-Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
I _{IH}	Input HIGH Current			150			150			150	μA
IIL	Input LOW Current	0.5			0.5			0.5			μA

Table 5. LVNECL DC CHARACTERISTICS $V_{CC} = 0.0 \text{ V}; V_{EE} = -3.3 \text{ V}$ (Note 3)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary ±0.3 V.

4. Outputs are terminated through a 50 Ω resistor to V_{CC} – 2.0 V.

				-40°C			25°C			85°C		
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Toggle Frequency			700			700			700		MHz
t _{PLH} t _{PHL}	Propagation Delay to Output	A Input SEL0 SEL1 SEL2 SEL3	350 500 400 400 400	600 700 675 675 550	850 900 900 900 700	350 500 400 400 400	600 700 675 675 550	850 900 900 900 700	350 500 400 400 400	600 700 675 675 550	850 900 900 900 700	ps
t _{SKEW}	Within Device Skew (Note 6)			75			50			50		ps
t JITTER	RMS Random Clock Jitter			<1			<1			<1		ps
t _r t _f	Rise/Fall Times (20% - 80%))	275	400	550	275	400	550	275	400	550	ps

Table 6. AC CHARACTERISTICS V_{CC} = 3.3 V; V_{EE} = 0.0 V or V_{CC} = 0.0 V; V_{EE} = -3.3 V (Note 5)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. V_{EE} can vary ±0.3 V.

6. Within Device skew is defined as the difference in the A to Q delay between the 16 different A inputs.

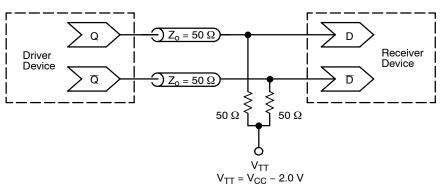


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

Resource Reference of Application Notes

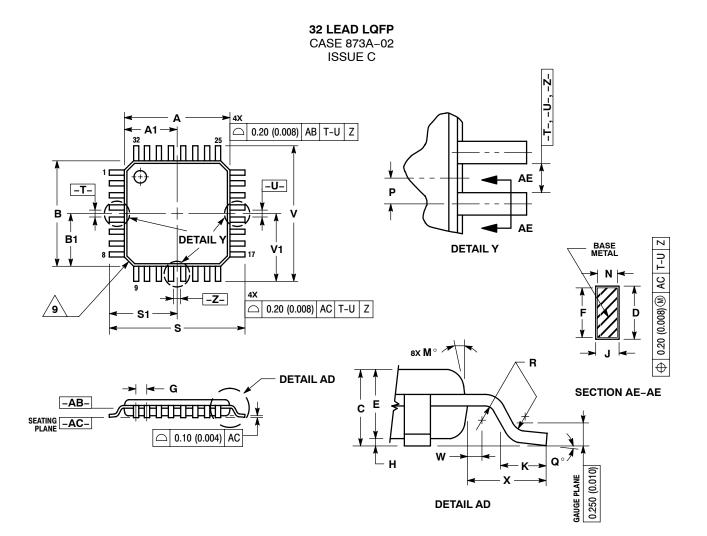
AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS [™] I/O SPiCE Modeling Kit
AN1504/D	_	Metastability and the ECLinPS Family
AN1568/D	_	Interfacing Between LVDS and ECL
AN1672/D	_	The ECL Translator Guide
AND8001/D	_	Odd Number Counters Design
AND8002/D	_	Marking and Date Codes
AND8020/D	_	Termination of ECL Logic Devices
AND8066/D	_	Interfacing with ECLinPS
AND8090/D	-	AC Characteristics of ECL Devices

ORDERING INFORMATION

Device	Package	Shipping [†]
MC100LVE164FA	LQFP	250 Units / Rail
MC100LVE164FAG	LQFP (Pb-Free)	250 Units / Rail
MC100LVE164FAR2	LQFP	2000 / Tape & Reel
MC100LVE164FAR2G	LQFP (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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